PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date	
Hiroki Kiyama	04/03/2009	
Kenichi Yokouchi	04/03/2009	

RECEIVING PARTY DATA

Name:	Dainippon Screen Mfg. Co., Ltd.	
Street Address:	Tenjinkita-cho 1-1, Teranouchi-agaru 4-chome	
City:	Horikawa-dori, Kamigyo-ku, Kyoto	
State/Country:	JAPAN	
Postal Code:	602-8585	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12421896

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	P/1250-367 (V11758)
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NAME OF SUBMITTER: Max Moskowitz

Total Attachments: 1 source=01022625#page1.tif

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PATENT REEL: 022533 FRAME: 0626 PATENT APPLICATION ASSIGNMENT-SOLE OR JOINT INVENTORS EXECUTED OUTSIDE U.S.A.

OFGS FILE NO. P//2	50-367	(_)
CVII	158)			

WHEREAS, I (We), Hiroki KIYAMA and Kenichi YOKOUCHI of c/o DAINIPPON SCREEN MFG. CO., LTD. of Tenjinkita-cho 1-1, Teranouchi-agaru 4-chome, Horikawa-dori, Kamigyo-ku, Kyoto 602-8585, Japan

as assignor(s), have invented certain improvements in

HEAT TREATMENT APPARATUS AND METHOD FOR HEATING SUBSTRATE BY LIGHT IRRADIATION for which an application for United States Letters Patent has been executed by me (us) signed on

April 3, 2009 ; and

WHEREAS, DAINIPPON SCREEN MFG. CO., LTD. of Tenjinkita-cho Teranouchi-agaru 4-chome, Horikawa-dori, Kamigyo-ku, Kyoto 602-8585, Japan as assignee, is desirous of acquiring all right, title and interest in and to said invention and any Patent that may be granted therefor.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I (We), as assignor(s), hereby sell, assign and set over to said assignee the entire right, title and interest for the United States and all other countries in and to said invention and the aforesaid application for Patent, all original, divisional, continuation, substitute or reissue applications and patents applied for or granted therefor in the United States and all other countries, including all rights of priority from the filing of said application, and all rights for past infringement, and the Commissioner of Patents and Trademarks is hereby authorized and requested to issue all patents on said inventions or resulting therefrom to said assignee herein, as assignee of the entire interest therein; and the undersigned for myself (ourselves) and my (our) legal representatives, heirs and assigns do hereby agree and covenant without further remuneration, to execute and deliver all divisional, continuation, reissue and other applications for Patent on said inventions and all assignments thereof to said assignee or its assigns, to communicate to said assignee or its representatives all facts known to the undersigned respecting said inventions, whenever requested, to testify in any interferences or other legal proceedings in which any of said applications or patents may become involved, to sign all lawful papers, make all rightful oaths, and to do generally everything necessary to assist assignee, its successors, assigns and nominees to obtain patent protection for said invention in the United States and all other countries, the expenses incident to said applications to be borne and paid by said assignee.

Date: 3/4/2009

Hiroki Kiyama Hiroki KIYAMA Kenichi Yokouchi

Date: 3/4/2009

LEGALIZATION RECOMMENDED

AMDT\41795

RECORDED: 04/10/2009

PATENT REEL: 022533 FRAME: 0627